# 503141545 01/19/2015

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
MANGESH ABHIMANYU INGALE	01/19/2015
HIMKE VAN DER VELDE	01/19/2015
RAJAVELSAMY RAJADURAI	01/19/2015
WOO-SEONG KIM	01/19/2015

#### **RECEIVING PARTY DATA**

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State/Country:	KOREA, REPUBLIC OF
Postal Code:	443-742

## **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	14599928	

## **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	WILLIAM A. MUNCK	
SIGNATURE:	/William A. Munck/	
DATE SIGNED:	01/19/2015	

**Total Attachments: 2** 

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PATENT REEL: 034747 FRAME: 0200 source=Assignment#page2.tif

PATENT REEL: 034747 FRAME: 0201

#### **ASSIGNMENT**

WHEREAS, We, Mangesh Abhimanyu INGALE, resident of Bangalore, India, citizen of India, Himke VAN DER VELDE, resident of Staines, Middlesex, United Kingdom, citizen of the Netherlands, Rajavelsamy RAJADURAI, resident of Bangalore, India, citizen of India, and Woo-Seong KIM, resident of Gwacheon-si, Gyeonggi-do, Republic of Korea, citizen of Republic of Korea, have invented certain new and useful improvements in a "DUAL CONNECTIVITY MODE OF OPERATION OF A USER EQUIPMENT IN A WIRELESS COMMUNICATION NETWORK" disclosed in an application for United States Letters Patent (Application Serial No. \_\_/\_\_\_\_\_, filed on \_\_\_\_\_\_\_, said application having been executed concurrently herewith;

WHEREAS, SAMSUNG ELECTRONICS CO., LTD, a corporation organized under the laws of the Republic of Korea, having a place of business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 443-742, Republic of Korea (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring our entire right, title and interest in and to the invention, and in and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title and interest in and to said invention and in and to said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, continuations-in-part and extensions thereof; We authorize William A. Munck of Munck Wilson Mandala, LLP to insert in the parenthesis above the application number and filing date of said application when known; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as our interest is concerned, to the said ASSIGNEE of our entire right, title and interest.

We also hereby sell and assign to said ASSIGNEE, its successors, assigns and legal representatives the full and exclusive rights, title and interest to the invention disclosed in said application throughout the world, including the right to file applications and obtain patents, utility models, industrial models and designs for said invention in its own name throughout the world including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention and all rights to register said invention in appropriate registries; and we further agree to execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any other papers in connection therewith necessary to perfect such rights, title and interest in ASSIGNEE, its successors, assigns and legal representatives.

We hereby further agree that we will communicate to said ASSIGNEE, or to its successor s, assigns and legal representatives, any facts known to us respecting any improvements; and, at t he expense of said ASSIGNEE, to testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, continuation-in-part, reissue and substitute applications, and make al lawful oaths, and generally do everything possible to vest title in said ASSIGNEE and to aid said ASSIGNEE, its successors, assigns and legal representatives to obtain and enforce proper prote ction for said invention in all countries.

Date: Jan	uam 19,	2015
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Mangesh Abhimanyu INGALE

Date: January 19, 2015

Himke VAN DER VELDE

Date: January 19, 2015

Rajavelsamy RAJADURAI

Date: January 19, 2015

Woo-Seong KIM